



# P-Channel 30-V (D-S) MOSFET

MOSFET PRODUCT SUMMARY						
V <sub>DS</sub> (V)	$R_{DS(on)}\left(\Omega\right)$	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)			
- 30	0.190 at V <sub>GS</sub> = - 10 V	- 2.7	2 nC			
	0.330 at V <sub>GS</sub> = - 4.5 V	- 2.1	2110			

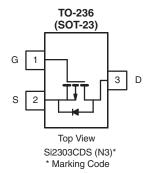
#### **FEATURES**

- Halogen-free According to IEC 61249-2-21 Available
- TrenchFET® Power MOSFET
- 100 % R<sub>g</sub> Tested
- 100 % UIS Tested



#### **APPLICATIONS**

· Load Switch



Ordering Information: Si2303CDS-T1-E3 (Lead (Pb)-free)

Si2303CDS-T1-GE3 (Lead (Pb)-free and Halogen-free)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	- 30	V	
Gate-Source Voltage	V <sub>GS</sub>	± 20	v	
	T <sub>C</sub> = 25 °C		- 2.7	
Continuous Drain Current (T <sub>.1</sub> = 150 °C)	$T_C = 70  ^{\circ}C$	I <sub>D</sub>	- 2.2	
Commission Prairie Carretta (1) = 100 °C)	T <sub>A</sub> = 25 °C	υ.	- 1.9 <sup>b, c</sup>	
	T <sub>A</sub> = 70 °C		- 1.5 <sup>b, c</sup>	Α .
Pulsed Drain Current	I <sub>DM</sub>	- 10	^	
Continuous Source-Drain Diode Current	T <sub>C</sub> = 25 °C	I <sub>S</sub>	- 1.75	
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	'5	- 0.83 <sup>b, c</sup>	
Avalanche Current	L = 0.1 mH	I <sub>AS</sub>	- 5	
Single Pulse Avalanche Energy	L = 0.1 IIII1	E <sub>AS</sub>	1.25	mJ
	T <sub>C</sub> = 25 °C		2.3	
Maximum Power Dissipation	$T_C = 70  ^{\circ}C$	PD	1.5	w
Maximum r ower Dissipation	T <sub>A</sub> = 25 °C	, п	1.0 <sup>b, c</sup>	VV
	T <sub>A</sub> = 70 °C		0.7 <sup>b, c</sup>	
Operating Junction and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS							
Parameter		Symbol	Typical	Maximum	Unit		
Maximum Junction-to-Ambient <sup>b, d</sup>	≤ 5 s	R <sub>thJA</sub>	80	120	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	$R_{thJF}$	35	55	O/ <b>VV</b>		

#### Notes:

- a. Based on  $T_C$  = 25 °C.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 5 s.
- d. Maximum under Steady State conditions is 160 °C/W.

# Si2303CDS

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{DS} = 0 \text{ V}, I_{D} = -250 \mu\text{A}$	- 30			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$			- 27		m\//°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I <sub>D</sub> = - 250 μA		3.8		mV/°C	
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 1		- 3	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zava Cata Valtaga Dvain Curvent	1	V <sub>DS</sub> = - 30 V, V <sub>GS</sub> = 0 V			- 1	μΑ	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = -30 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			- 10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \le -5 \text{ V}, V_{GS} = -10 \text{ V}$	- 10			Α	
	В	V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 1.9 A		0.158	0.190		
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 1.4 A		0.275	0.330	Ω	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 5 V, I <sub>D</sub> = - 1.9 A		2		S	
Dynamic <sup>b</sup>						-	
Input Capacitance	C <sub>iss</sub>			155			
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = 0 V, f = 1 MHz		35		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			25			
	0	V <sub>DS</sub> = - 15 V, V <sub>GS</sub> = - 10 V, I <sub>D</sub> = - 1.9 A		4	8	nC	
Total Gate Charge	Qg			2	4		
Gate-Source Charge	$Q_{gs}$	$V_{DS} = -15 \text{ V}, V_{GS} = -4.5 \text{ V}, I_{D} = -1.9 \text{ A}$		0.6			
Gate-Drain Charge	$Q_{gd}$			1			
Gate Resistance	$R_g$	f = 1 MHz	1.7	8.5	17	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			4	8		
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 15 V, $R_L$ = 10 $\Omega$		11	18	]	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D = -1.5 \text{ A}, V_{GEN} = -10 \text{ V}, R_G = 1 \Omega$		11	18		
Fall Time	t <sub>f</sub>			8	16	]	
Turn-On Delay Time	t <sub>d(on)</sub>			36	44	ns	
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 15 V, $R_L$ = 10 $\Omega$		37	45		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D \cong$ - 1.5 A, $V_{GEN}$ = - 4.5 V, $R_G$ = 1 $\Omega$		12	18		
Fall Time	t <sub>f</sub>			9	14	1	
<b>Drain-Source Body Diode Characteristi</b>	cs						
Continuous Source-Drain Diode Current	I <sub>S</sub>	$T_C = 25  ^{\circ}C$			- 1.75	_	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				- 10	Α	
Body Diode Voltage	$V_{SD}$	I <sub>S</sub> = - 1.5 A		- 0.8	- 1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			17	26	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = - 1.5 A, di/dt = 100 A/μs, T <sub>.I</sub> = 25 °C		9	14	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$I_{F} = -1.5 \text{ A}$ , $I_{J} = 25 \text{ C}$		12			
Reverse Recovery Rise Time	t <sub>b</sub>			5		ns	

#### Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

a. Pulse test; pulse width  $\leq 300~\mu s,$  duty cycle  $\leq 2~\%.$ 

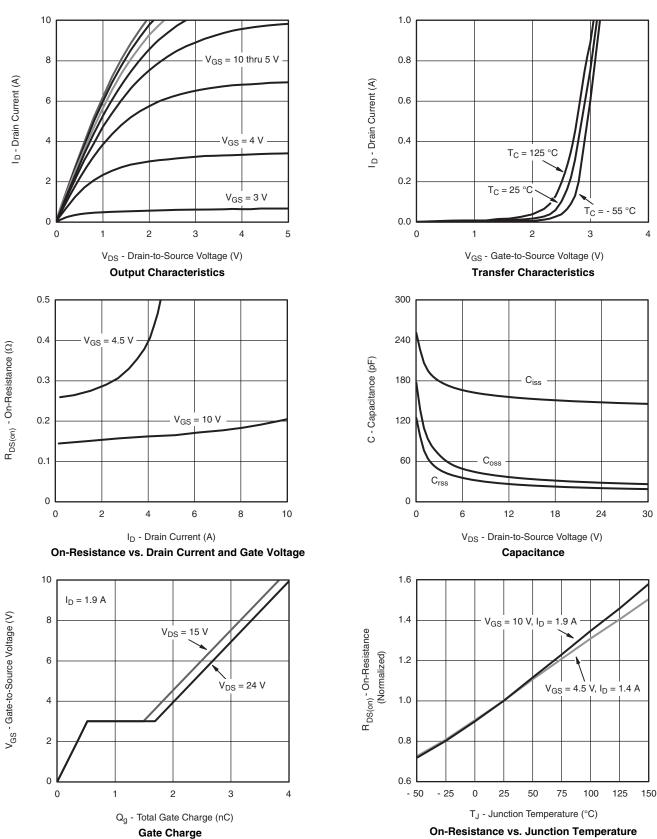
b. Guaranteed by design, not subject to production testing.







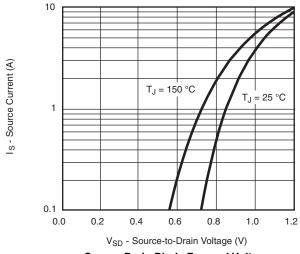
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



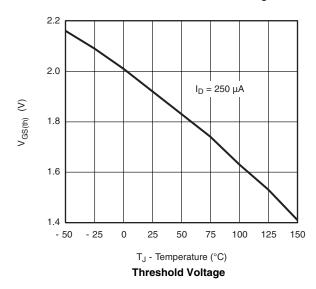
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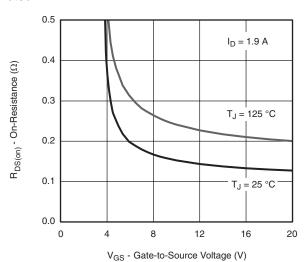
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## TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

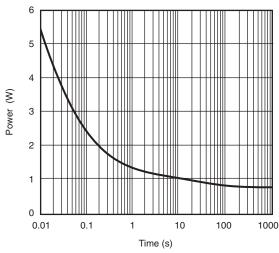


#### Source-Drain Diode Forward Voltage

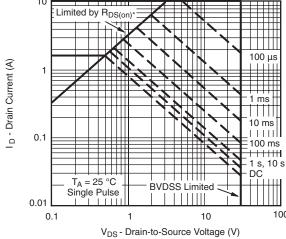




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power

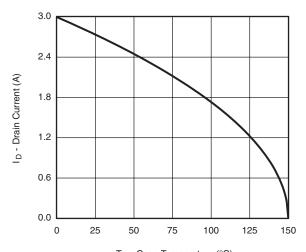


\* V<sub>GS</sub> > minimum V<sub>GS</sub> at which R<sub>DS(on)</sub> is specified

Safe Operating Area

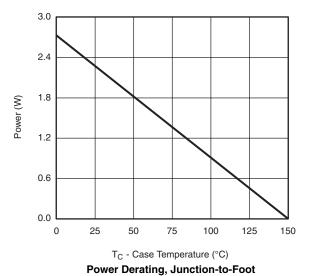


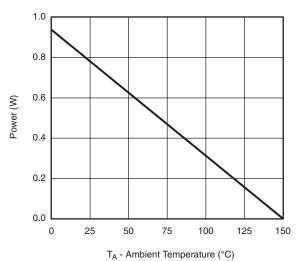
#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



T<sub>C</sub> - Case Temperature (°C)

#### **Current Derating\***





Power Derating, Junction-to-Ambient

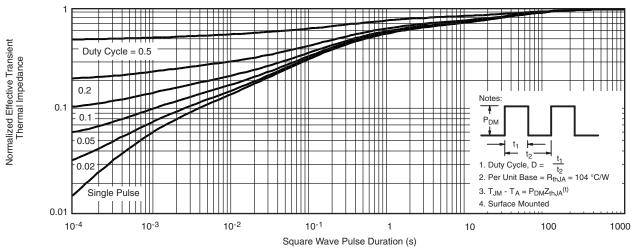
Document Number: 69991 S-83053-Rev. B, 29-Dec-08

<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max.)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

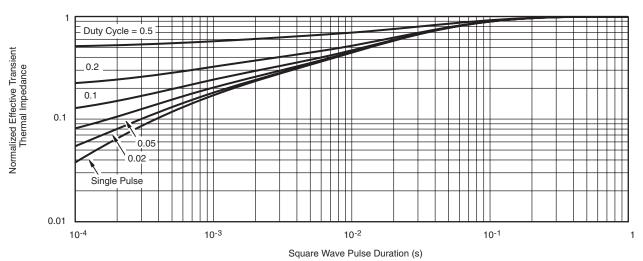
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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



#### Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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## SOT-23 (TO-236): 3-LEAD







Dim	MILLI	METERS	INCHES		
	Min	Max	Min	Max	
Α	0.89	1.12	0.035	0.044	
A <sub>1</sub>	0.01	0.10	0.0004	0.004	
A <sub>2</sub>	0.88	1.02	0.0346	0.040	
b	0.35	0.50	0.014	0.020	
С	0.085	0.18	0.003	0.007	
D	2.80	3.04	0.110	0.120	
E	2.10	2.64	0.083	0.104	
E <sub>1</sub>	1.20	1.40	0.047	0.055	
е	0.9	5 BSC 0.0374 Re		Ref	
e <sub>1</sub>	1.9	0 BSC	0.074	8 Ref	
L	0.40	0.60	0.016	0.024	
L <sub>1</sub>	0.64 Ref		0.025 Ref		
S	0.50 Ref		0.020 Ref		
q	3°	8°	3°	8°	
FCN: S-03946-Rev K 09-	lul-01	•			

ECN: S-03946-Rev. K, 09-Jul-01

DWG: 5479

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#### **RECOMMENDED MINIMUM PADS FOR SOT-23**



Recommended Minimum Pads Dimensions in Inches/(mm)

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APPLICATION NOTE



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